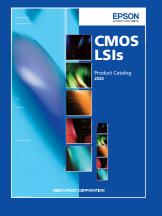


EPSON Microcontrollers



ASICs



America

Epson America, Inc.

3840 Kilroy Airport Way Long Beach, California 90806-2452 USA Phone: +1-562-290-4677

San Jose Office: 214 Devcon Drive San Jose, CA 95112 USA Phone: +1-800-228-3964 or +1-408-922-0200

Epson Europe Electronics GmbH

Riesstrasse 15, 80992 Munich, Germany Phone: +49-89-14005-0 FAX: +49-89-14005-110

Asia

Epson (China) Co., Ltd.

4th Floor, Tower 1 of China Central Place, 81 Jianguo Road, Chaoyang District, Beijing 100025 China Phone: +86-10-8522-1199 FAX: +86-10-8522-1120

Shanghai Branch Room 1701 & 1704, 17 Floor, Greenland Center II, 562 Dong An Road, Xu Hui District, Shanghai, China Phone: +86-21-5330-4888 FAX: +86-21-5423-4677

Room 804-805, 8 Floor, Tower 2, Ali Center, No.3331 Keyuan South RD(Shenzhen bay), Nanshan District, Shenzhen 518054, China Phone: +86-10-3299-0588 FAX: +86-10-3299-0560

Epson Taiwan Technology & Trading Ltd. 15F., No. 100, Songren Rd., Sinyi Dist., Taipei City 110. Taiwan

Epson Singapore Pte., Ltd.1 HarbourFront Place, #03-02 HarbourFront Tower One, Singapore 098633 Phone: +65-6586-5500 FAX: +65-6271-3182

Epson Korea Co., Ltd.

10F Posco Tower Yeoksam, Teheranro 134 Gangnam-gu, Seoul, 06235, Korea Phone: +82-2-3420-6695

Seiko Epson Corp. **Sales & Marketing Division**

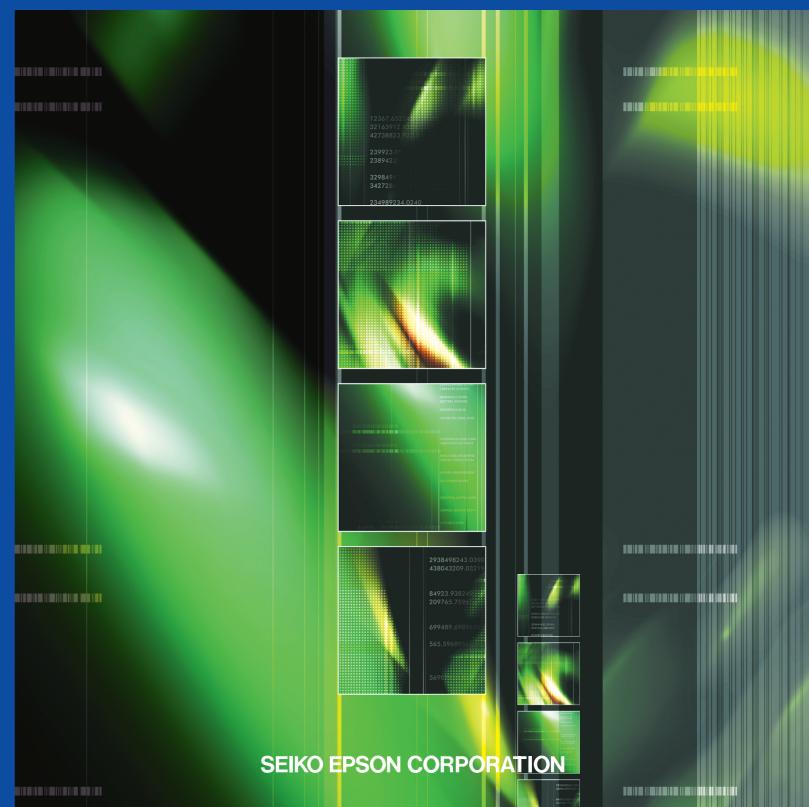
Device Sales & Marketing Department

29th Floor, JR Shinjuku Miraina Tower, 4-1-6 Shinjuku, Shinjuku-ku, Tokyo Phone: +81-3-5368-0700

Document code : 701078827

First Issue April 2002 Revised March 2020 in JAPAN \oplus

Microcontrollers



Business Concept

Expanding use of smartphones and tablets is giving broadband internet and wireless communications even greater roles in our daily lives, and making the arrival of the ubiquitous network society an inevitable reality. In particular, semiconductors for use in portable devices, information terminals, in-vehicle devices and FA devices are expected to provide higher performance in terms of thinner structure, lighter weight, and longer operation with limited power supply. We have been focusing on the creation of compact, low-power semiconductors since we started the development of CMOS LSI for watches in 1969. Since then, we have steadily built up our expertise in energy-saving, space-saving, and time-saving designs. This has enabled us to quickly obtain the semiconductor development technology needed to meet the demands of the new era of ubiquitous networks. Our concept is to develop "saving technologies" to reduce power consumption, development times, and implementation space. Our goal is to be a true partner for you, providing you with strategic advantages, enhancing your customer value based on our "saving technologies" and mixed analog/ digital technologies that we have cultivated, as well as our design capabilities, manufacturing capabilities and stable supply that can satisfy your detailed requirements.

Environmental Responsibility

Epson semiconductor technology provides environmental value to customers by creating and manufacturing eco-friendly products.

1) We Epson's products are surely complying with the Eu-RoHS (2011/65/EU) Directive.

2) We are releasing information about the containing chemical substances of products at web-site.

Product of QFP & BGA are described in the following URL.

global epson com/products, and drivers/semicon/information/package, lineup html, *Some products.

global.epson.com/products_and_drivers/semicon/information/package_lineup.html *Some products are excluded.

Environmental management system third party certification status ISO14001

Type of certification: ISO 14001: 2015, JIS Q 14001: 2015

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION

(Fujimi Plant, Suwa Minami Plant) Certified by: Bureau Veritas Japan Co., Ltd.

Date of certification : April 3, 1999 Type of certification : ISO 14001: 2015

Awarded to : Singapore Epson Industrial Pte. Ltd.

Certified by: SGS

Date of certification: Jan 12, 1999







Epson's Quality Policy

Keeping the customer in mind at all times, we make the quality of our products and services our highest priority. From the quality-assurance efforts of each employee to the quality of our company as a whole, we devote ourselves to creating products and services that please our customers and earn their trust. Epson has acquired ISO9001 and IATF16949 certification with its IC, module and their application products.

Quality Management system third party certification status ISO9001

Type of Certification: ISO9001: 2015, JIS Q 9001: 2015

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION

(Fujimi Plant, Suwa Minami Plant, Hino Office)

Certified by: Bureau Veritas Japan Co., Ltd.

Certificate No.: 3762381

Initial Date of Certification : October 10, 1993

Type of Certification: ISO9001: 2015

Awarded to: Singapore Epson Industrial Pte. Ltd.

Certified by: SGS

Certificate No.: SG03/00011

Initial Date of Certification: February 4, 2003

IATF16949

Type of Certification: IATF16949:2016

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION (Fujimi Plant, Suwa Minami Plant, Hino Office), Epson Europe Electronics GmbH, Epson America, Inc., Epson Canada Ltd.(Vancouver Design Center)

Certified by: Bureau Veritas Japan Co., Ltd.

Certificate No.: 281371

Initial Date of Certification : Dec 9, 2017

Type of Certification: IATF16949:2016

Awarded to: Singapore Epson Industrial Pte. Ltd. Certified by: SGS

Certificate No.: SG07/00021

Initial Date of Certification : May 2, 2018

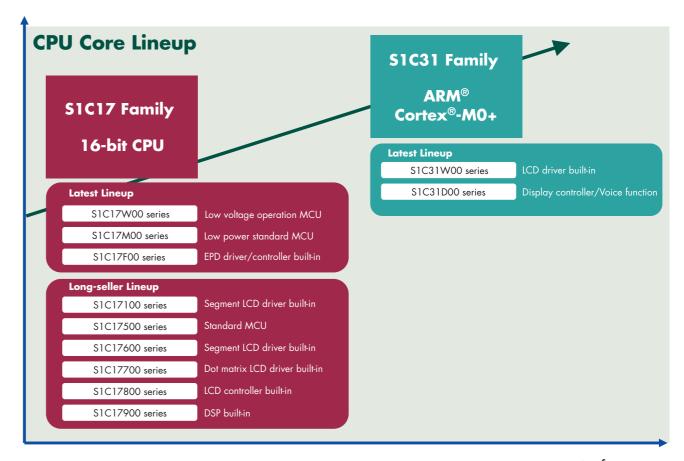












Performance

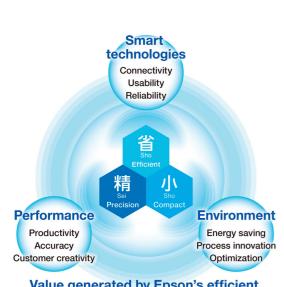
C O N T E N T S

History of Epson semiconductor	4-5	Epson MCU website	20-21
Epson microcontroller overview	6	Development environments	22-25
Features of Epson microcontrollers	7-9	Flash memory writing	26-27
S1C31 Family ARM® microcontrollers	10-13	Package lineup	28-29
S1C17 Family 16-bit microcontrollers	14-19		

MCUs

History of Epson semiconductor

Value Generated by Epson Technologies



Value generated by Epson's efficient, compact and precision technologies

Smart technologies

Create convenient and easy-to-use products that can be used anytime and anywhere, and which help customers reduce waste, and save effort, time and money.

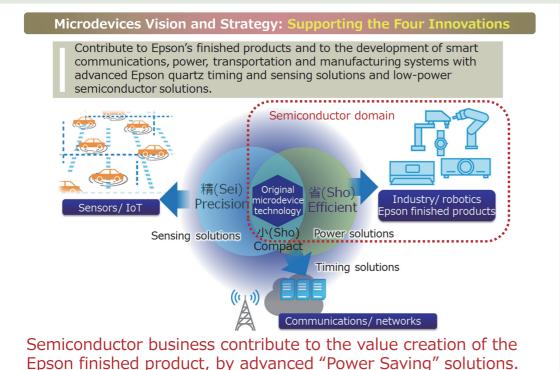
Environment

Leverage Epson products to reduce environmental impact by improving customers' work processes, and contribute to a sustainable society.

Performance

Use outstanding products to contribute to customers' performance through productivity, accuracy and creativity.

The role of Microdevices Div. and Semiconductor domain

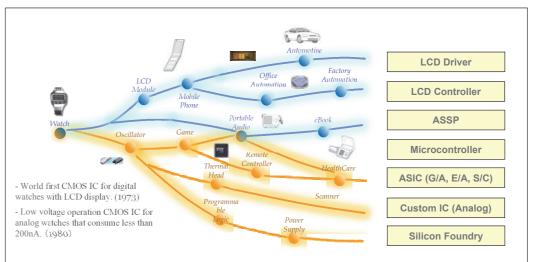


History of Epson semiconductor

MCUs

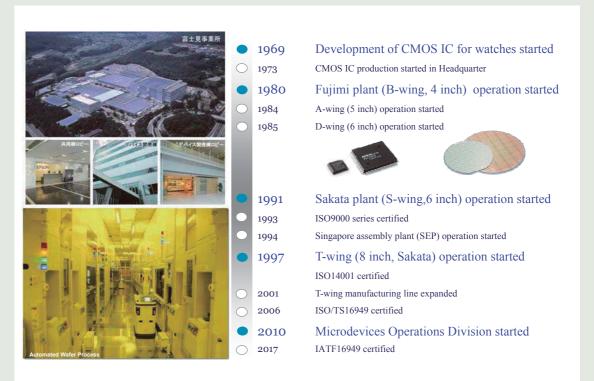
History of Epson Semiconductor's Technology

As the semiconductor division of "worldwide watch maker Seiko", semiconductor business has expanded into LCD Drivers, ASICs and MCUs from IC for Watches. These businesses are all based on Epson's energy-saving technology.



Energy-Saving Technology; Technology that reduces power consumption from both sides of process and circuit have been nurtured by Epson over 40 years since division was founded.

Epson Semiconductor's History



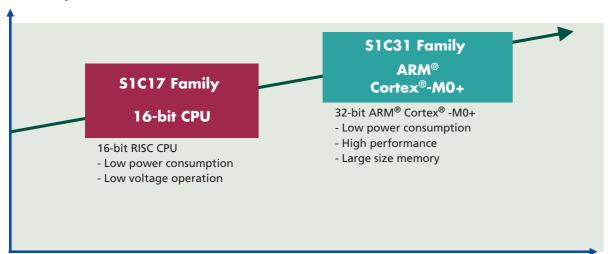
MC MC

Epson microcontroller overview

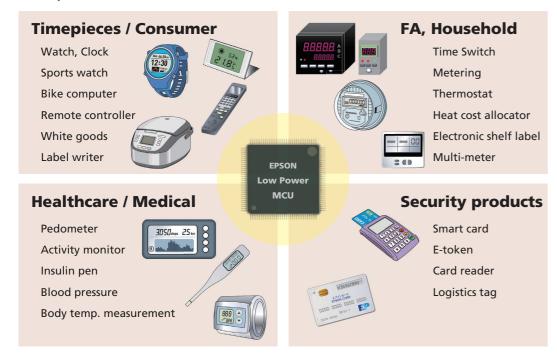
■ Low power microcontrollers

The technologies of low voltage operation and low power consumption acquired over the years through the development of 4-bit microcontrollers for watches and electronic shelf labels (ESL) are inherited by 16- and 32-bit microcontrollers today. The product lineup has been expanded, while achieving better throughputs. The display functions range from small-sized segment LDC drive to QVGA color display. A wide array of sensor interfaces recently attracting attention are also available. In addition to digital SIO such as SPI, UART, and I²C and the low power ADCs, the Epson original frequency conversion type ADC is capable of supporting measurements by resistance thermometer sensors and humidity sensors. A variety of these functions, low power technology and a highly efficient processor are all built into a single chip. With this one-chip solution, Epson continues to offer optimum products for small-sized battery-driven equipment, operation panel controllers, and sensor built-in healthcare products and housing equipment.

■ CPU Core Lineup



■ Application Example

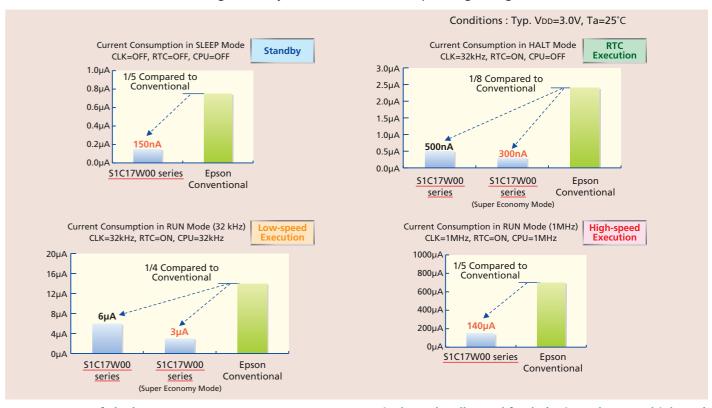


Features of Epson microcontrollers

MCUs

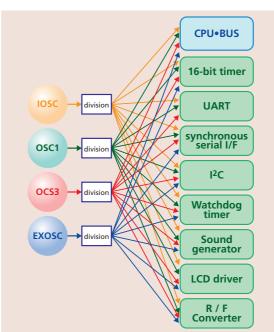
■ Lowest Current Consumption (16-bit microcontrollers)

In most cases, the S1C17 Family of products will allow customers currently using 8-bit microcontrollers to enjoy higher performance with the same power consumption. In addition, it will enable customers already using 16-bit/32-bit microcontrollers to benefit from longer battery life as a result of low operating voltage.



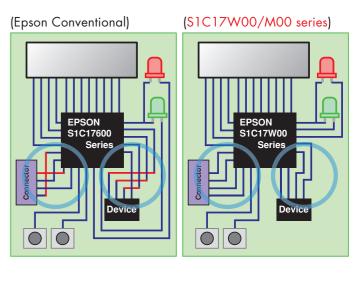
■ Four types of clock sources

Four types of characteristic clock sources can be freely selected for each circuit.



■ Terminals can be allocated freely (Universal Port Multiplexers)

SPI, I²C, UART, 16-bit PWM, and other terminals can be freely allocated as individual UPMUX terminals using software.



MCUs Features of Epson microcontrollers

Features of Epson microcontrollers

MCUs

■ Supporting various types of LCD

• Black & White LCD driver

- Segment LCD driver

- 12 to 88seg x 4/8com
- 1/3 bias LCD voltage booster built-in

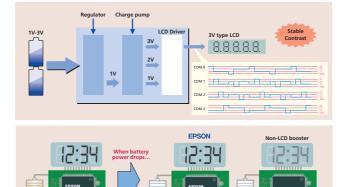
- Dot Matrix LCD driver

- 56 to 128seg x 16/24/32/64com
- 1/4,1/5 bias LCD voltage booster built-in

Models containing Black & White LCD driver:

- S1C17W10 group
- S1C17W20 group
- S1C17W30 group
- S1C17M30 group
- S1C17M40 group
- S1C31W00 series

Built-in power supply circuit



Segment LCD



Dot matrix LCD



LCD controller

- STN/TFT LCD controller

- 320 x 240monochrome / 320 x 240 (QVGA)16gradations

- Memory display controller

- 300 x 300 6-bit color / 640 x 640 Black & White
- Supporting graphic engine function

Models containing LCD controller:

- S1C17800 series
- S1C31D00 series

Segment EPD driver

- 42 to 256seg + TP/BP
- Voltage booster built-in

Models containing EPD driver:

- S1C17F00 series

Segment LED drive

- 8seg x 5com supporting 5V

Models containing LED driver:

- S1C17M12/M13

Memory display



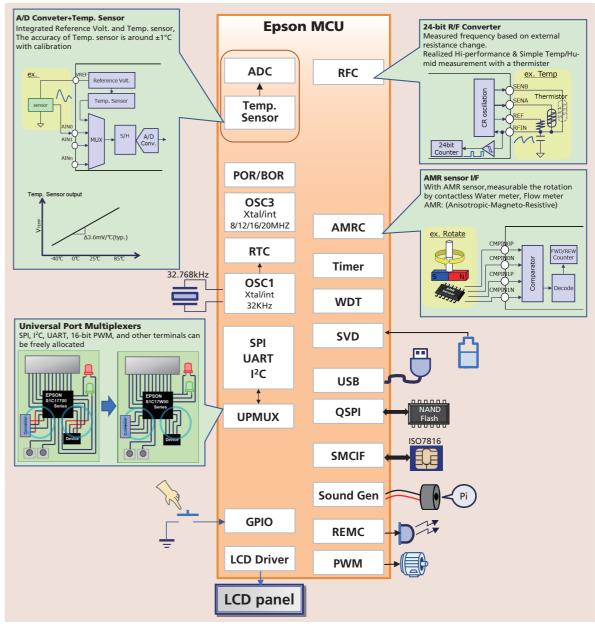
Segment EPD



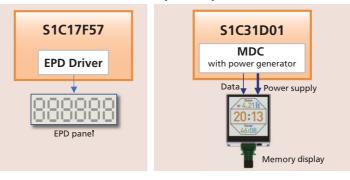
Segment LED

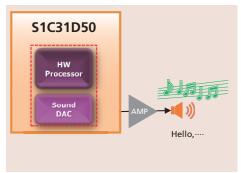


■ A large number of different types of interfaces are included



■ Product Dedicated Unique Peripherals





*: Peripheral circuits configured by products are different.

Suitable for wearable and industrial control devices

ARM® microcontroller with LCD driver S1C31W Series

■ General

The S1C31W series is 32-bit MCU with an ARM® Cortex®-M0+ processor included that features low-power operation. It integrates LCD driver (max. 2,560-dot) and a lot of serial interface circuits.

Large capacity memory

Large capacity memory corresponding to market trend of multi functionality is integrated on a single chip. It is possible to store and operate user programs that size is increasing by complicated software design.

Built-in high resolution LCD driver

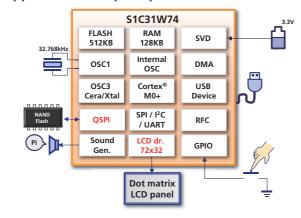
S1C31W series can drive dot-matrix or 7-segment LCD by built-in LCD driver. It equips internal constant voltage circuit that has been cultivated over the Epson traditional products, and can maintain display quality that is not affected by the remaining battery level. The contrast can be adjusted by software. It offers optimum and flexible design for user's product development.

Wide variety of interface

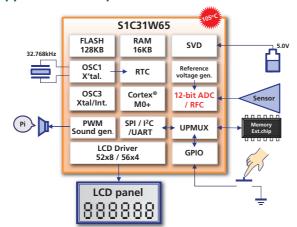
In addition to UART, SPI and I²C, it supports Quad-SPI (QSPI) which can communicate with external serial flash memory at high speed. An R/F converter for temperature and humidity measurenent, USB FS 2.0 device controller, Universal port multiplexers that increase board layout design flexibility are also supported.

* It depends on the product which interface are supported.

■ Application example: Sport watch



■ Application example: Industrial control device



Suitable for battery-driven wearable products

ARM® microcontroller with a memory display controller "S1C31D01"



■ General

The S1C31D01 is a 32-bit MCU with an ARM® Cortex®-M0+ processor included that features low-power operation.

It integrates a lot of serial interface circuit, a memory display controller, and a voltage booster.

Memory Display Controller (MDC)

MDC supports several panel interfaces for each memory display. It includes graphics hardware acceleration functions such as rotation of frame buffer image to panel, Image/bitmap copy with scaling/rotation/ horizontal and vertical shearing/alpha-blending*, Line/Rectangle/Ellipse/ Arc drawing with filled and unfilled.

It can contributs to reduce software load by dedicated hardware.

Power booster circuit

The S1C31D01 generates supply voltages for memory display (VMDH/ VMDL) with programmable power booster curcuit. It is possible to reduce external components.

Small size package

Wafer level Chip Size Package (WCSP) is supported as same size with chip. It is suitable for various applications which have limited mounting area on the print circuit board.

Lineup

Epson prepares CPU-less dedicated memory display controller "S1D13C00" for the customers who already have Host CPU. It supports same features with S1C31D01 about graphic accereration function and power booster circuit. There is a variety of products that can be selected according to your system.

■ Examples of Graphic Acceleration **Drawing Engine**



Imge / Bitmap copy

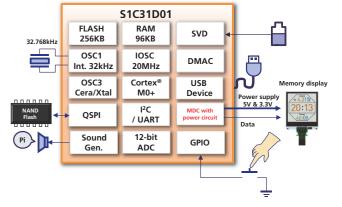








■ Application Example: Sport watch



* Alpha-blending: supported at 6-bit color only

■ S1C31W Series Products overview

	Display		Operation cloc	k		Supply	current		Power supply		Memory		I/O		Tim	er				SIO				Analog		Rese	et		Others	s	Form of deli	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [µA] (Typ.)	mode1 Operating [μΑ] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	Display RAM [Byte]	RAM [Byte]	I/O port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	I ² C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD	POR	BOR	Sound	NSB S	Special function	Package	Chip
S1C31W65	52 x 8 56 x 4	33M	32.768k	32k/1M/2M/ 8M/12M/16M/ 24M/32M	TBD	TBD	TBD	TBD	1.8 to 5.5	128K	112	16K	64	8	3 x 4	1	1	2	2	-	2	1	1	7	1	0	0	1	-	DMA	TQFP14-100	-
S1C31W73	96 x 16 88 x 24 80 x 32	33M	32.768k	32k/1M/2M/ 8M/12M/16M/ 24M/32M	TBD	TBD	TBD	TBD	1.8 to 5.5	384K	768	32K	73	8	2 x 4	1	1	2	2	1	2	1	1	7	1	0	0	1	1	DMA	QFP21-216	0
S1C31W74	88 x 16 80 x 24 72 x 32	21M	32.768k	1M/2M/8M/ 12M/16M/20M	0.4	1.7	250	150	1.8 to 3.6	512K	704	128K	71	4	2 x 2	1	1	2	1	1	2	1	1	-	2	0	0	1	1	-	VFBGA8H-181	0

■ S1C31D Series Products overview

	Display		Operation cl	lock		Supply	current		Power supply	Mer	mory	VO		Time	er			SIO				Analog		Res	set		Others	rs	Form of deli	livery
Products	Display controller	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [µA] (Typ.)	mode1 Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI Quad SPI	PC	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD	POR	BOR	Sound generator	USB	Special function	Package	Chip
S1C31D01	MDC	21M	32.768k	32k/1M/2M/ 8M/12M/16M/20M	0.46	1.7	250	155	1.8 to 5.5	256K	96K	57	8	2 x 6	1	1	3	2 1	2	1	-	7	1	0	0	1	1	DMA	WCSP96 TQFP14-80 VFBGA5H-81	0
S1C31D50 / 51	-	16M	32.768k	32k/4M/8M/16M	0.46	1.8	250	155	1.8 to 5.5	192K	8K	39 55 71 91	8	2 x 4	1	1	3	3 1	3	1	1	5 7 8	1	0	0	-	-	DMA Sound HW	TQFP12-48 QFP13-64 TQFP14-80 QFP15-100	-

MCUs MCUs

ideal sound solution for home appliances and electronics

ARM® microcontroller with Dedicated Sound Hardware "\$1C31D50/51"

■ General

The S1C31D50/51 is a 32-bit ARM® Cortex®-M0+ MCU which integrates a specific hardware block called the HW Processor.

HW Processor

The HW Processor can perform 2ch Voice/Audio Play, Voice Speed Conversion, and Self Memory Check without using any CPU resources.

2ch mixing play

A dedicated HW Processor provides 2-channel sound on a single MCU chip. The use of two channels enables music and voice to be played simultaneously. The audio guidance becomes more elegant and warmer.

Voice Speed Conversion

Without changing the voice, the speed can be adjusted from 75% to 125% by 5% step.

High-compression Sound Algorithm

Epson high-compression algorithm(EOV) cultivated in Epson LSI business is inherited. For example, the data size of 1min voice at 15.625kHz sampling frequency is about 120KB. It is 1/4 size of the data created by ADPCM.

Self-Memory Check

HW processor can detect failures in built-in RAM, built-in Flash, and external SPI-Flash memories without using CPU resources.

■ Main Features

Flash 192KB(for Program & Voice ROM)

RAM 8KB(Disable HW Processor time: up to 22KB)

HW Processor Voice/Audio Play w/o CPU resource

- 2ch mixing play

- Voice Speed Conversion

- Self-Memory Check w/o CPU resource

Sound DAC Sampling Frequency 15.625kHz
Serial Interface SPI(3ch), UART(3ch), I²C(3ch), QSPI(1ch)

12 hit/9 nort)

SVD Supply Voltage Detector (32level, 1.7V to 4.3V)

DMA 4ch

RFC CR oscillation type with 24-bit counters

Timers 16-bit Timer, 16-bit PWM, WDT, RTC

Power Supply 1.8V to 5.5V

3.3V SPI Flash Interface Power Supply

clock frequency Max. 16MHz (internal power: 1.8V)

Max. 1.8MHz (internal power: 1.2V)

current consumption

RUN:250µA/MHz (internal power : 1.8V)

RUN:150µA/MHz (internal power : 1.2V)

SLEEP:0.4μA, RTC mode : 0.9μA

Package TQFP12-48 (7mm x 7mm, 0.5mm pitch)

QFP13-64 (10mm x 10mm, 0.5mm pitch) TQFP14-80 (12mm x 12mm, 0.5mm pitch)

QFP15-100 (14mm x 14mm, 0.5mm pitch)

Applications

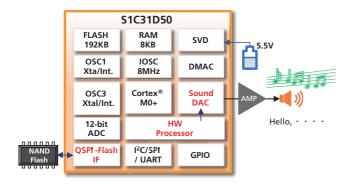
Boiler Remote Controller Fire/Smoke Alarm







■ Block Diagram



Voice Creation PC Tool, Simple sound play interface, easy sound data update in market

MCUs

S1C31D50/51 Development Environment provides User-Friendly Substantial Development, this makes it easy to create natural voice data and play the sound.

■ Epson Voice Creation PC Tool

Using Epson Voice Creation PC Tool, natural voice data can be created by just PC, so no need to struggle studio recording, announce arrangement and additional cost. Typically only text input to the tool is enough to create the voice data. The tool also supports phrase combination, pronunciation adjust and importing existing WAV file a customer already has.

[Supported Languages]

Asia : Japanese, Chinese (Mandarin), Korean America : American English, American Spanish,

Canadian French

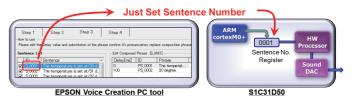
Europe : British English, German, French, Spanish,

Italian, Russian



■ Link between Voice creation Tool and IC

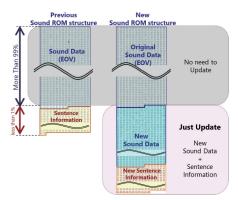
Epson Voice Creation PC tool also makes it easy to develop firmware. A firmware engineer does not need to care phrase combination and delay among phrases etc, because all information is included in Sound ROM and Hardware Processor. By just setting the Sentence Number on the tool to IC register, the sound can be played.



13

■ Sound ROM Update

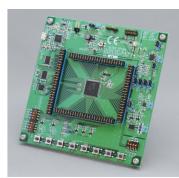
Sound ROM has a structure to update. The exisiting data does not need to do anything, only NEW "Data & Sound Information" is enough. This makes possible to update the sound after market launch.



■ Evaluation Board

4 languages sound demo with melody is preset. Pushing the button on the evaluation board, 2ch mixing sound can be played.

Also customers can write new sound ROM Data from PC to this board and play own sound easily.



S1C17 Family 16-bit microcontrollers

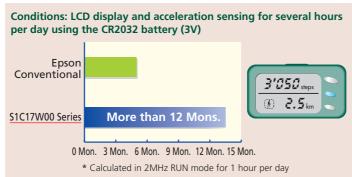
S1C17 Family 16-bit microcontrollers

■ World realized by low power consumption of the S1C17W Series



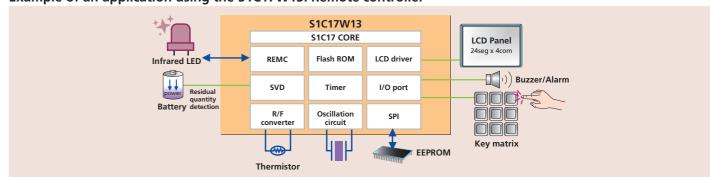
* Calculated in 32kHz RUN mode for 10m per second





■ S1C17W Series Application examples

Example of an application using the S1C17W13: Remote controller



■ S1C17W Series Products overview

	Display		Operation clock			Supply	current		Power supply	Men	nory	VO		Tir	mer				SIO				Analog			Ot	hers	Form of delive	ery
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [μΑ] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	RAM [Byte]	I/O port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	QSPI	I ² C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD *4	Sound	Multiplie r/Divider	Special function	Package	Chip
S1C17W00 series	/W00 group								1.2V, even with bu									s an interna driven appl		voltage, to	drive an IO	C with a lov	w power c	onsumptio	on operation	on beyond	1-bit MCUs.		
S1C17W03	-	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	16K *3	2K	35 24	4	2 x 2	1	1	2	2	-	1	1	2*5 1	6 5	1	1	1	-	TQFP12-48 SQFN5-32	o -
S1C17W04	-	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	32K *3	2K	35 24	4	2 x 2	1	1	2	2	-	1	1	2*5 1	6 5	1	1	1	-	TQFP12-48 SQFN5-32	o -
S1C17W00 series	/W10/W20/W30 group								1.2V, even with b					highly efficience					al constant	voltage, t	o drive an I	IC with a lo	ow power	consumpti	ion operat	ion beyond	4-bit MCUs. This produ	uct is equipped with a b	uilt-in RTC,
S1C17W12	26 x 4	4.2M	32.768k	32k/250k/ 384k/500k/ 700k/1M/	0.15	0.3	2	140	1.2 to 3.6	48K	2K	32	3	2 x 2	1	1	2	1	-	1	1	2	-	1	1	1	LED pin x 2	-	0
	18 x 4		-	2M/4M		1.5	5					26																SQFN7-48	-
S1C17W13	26 x 4 18 x 4 20 x 4	4.2M	32.768k	32k/250k/ 384k/500k/ 700k/1M/ 2M/4M	0.15	0.3	4	140	1.2 to 3.6	48K *3	2K	26	3	2 x 2	1	1	2	1	-	1	1	2 *5	-	1	1	1	LED pin x 2	QFP13-64 SQFN7-48 TQFP12-48	0
S1C17W14	*7 54 x 4 50 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	3	200	1.2 to 3.6	48K *3	4K	33	3	2 x 2	1	1	2	2	-	1	1	1	-	1	1	1	-	QFP15-100	0
S1C17W15	34 x 4 30 x 8 32 x 4 28 x 8 24 x 4 20 x 8	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	64K *3	4K	36 33 28	3	2 x 2	1	1	2	1	-	1	-	4 *5	-	1	1	1	-	QFP15-100 TQFP14-80 SQFN9-64 TQFP13-64	0
S1C17W16	60 x 4 56 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	3	200	1.2 to 3.6	64K *3	8K	40	5	2 x 2	1	1	2	3	-	1	1	2	4	1	1	1	-	TQFP15-128	0
	48 x 4 44 x 8					0.3	2					68																TQFP15-128	
S1C17W18	32 x 4 28 x 8 24 x 4	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.5	4	140	1.2 to 3.6	128K (*3)	8K	59	4	3 x 2	1	1	2	2	-	1	1	2 *5	7	1	1	1	Temperature sensor	TQFP14-80	0
S1C17W22	20 x 8 72 x 4/8 64 x 16	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	64K *3	4K	49	2	2 x 2	1	1	1	1	-	1	1	2	-	1	1	1	-	SQFN9-64 TQFP15-128	0
S1C17W23	56 x 24 72 x 4/8 64 x 16 56 x 24	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	96K *3	8K	42	4	3 x 2	1	1	2	2	-	1	1	2	6	1	1	1	-	TQFP15-128	0
S1C17W34	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6	128K (*3)	12K	53	4	3 x 2	1	3	2	2	-	1	1	2	7	1	1	1	Temperature sensor	QFP21-176	0
S1C17W35	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6	256K (*3)	12K	53	4	3 x 2	1	3	2	2	-	1	1	2	7	1	1	1	Temperature sensor	QFP21-176	0
S1C17W36	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6	384K (*3)	16K	53	4	3 x 2	1	3	2	2	-	1	1	2	7	1	1	1	Temperature sensor	QFP21-176	0

^{*1:} During erasing / programming in flash memory (VDD): 1.8V to 3.6 V

14

^{*2:} During operations LCD (VDD): 2.5V to 3.6V

^{*3:} During erasing / programming voltage in flash memory (VPP): The external applying of 7.5V / 7.5V (Typ.) is needed. (*3) can be rewritten even with internal power supply.

^{*4:} SVD is an abbreviation for Supply Voltage Detector.

^{*5:} Independent operation for each channel.

^{*6:} During erasing / programming in flash memory (VDD): 2.7V to 3.6V, 2.4V to 3.6V during the external applying VPP=7.5V/7.5V(Typ.)

^{*9:} During erasing / programming in flash memory (VDD): 2.4V to 3.6 V

^{*7:} External voltage application mode only.

^{*8:} Including Input port and Output port.

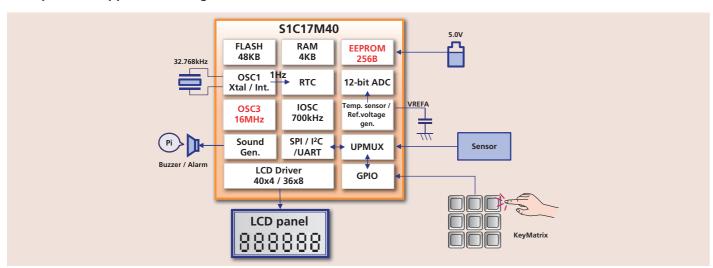
S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

MCUs

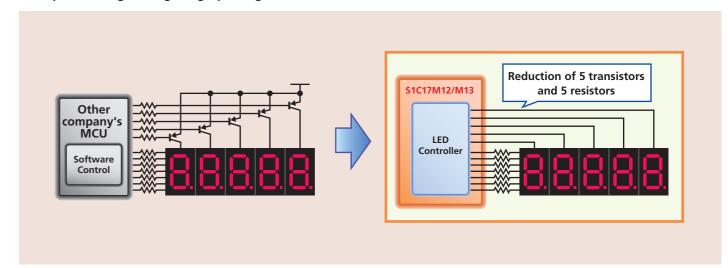
■ S1C17M Series Application examples

Example of an application using the S1C17M40: FA/Industrial control device



■ S1C17M Series Function introduction

Example of 7 seg LED lighting up using the S1C17M12/M13



■ S1C17M Series Products overview

	Displa	ay		Operation clo	ick		Supply	/ current		Power supply	,	Memory		I/O		Tin	ner				SIO				Analog		Re	set		Oth	ners	Form of de	livery
Products	LCD Driver seg×com	Display controller	High- speed [Hz] (Max.)	Low- speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	EEPROM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	I ² C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD*4	POR	BOR	Sound	Multiplie r/Divider	Special function	Package	Chip
S1C17M00 series		It is an applic supporting p	ation specializ	ed series. It is oltages from	a 16-bit MCU w 1.8 V to 5.5 V.	ith Flash mem	ory compatib	le with high pro	cessing while	achieving low	power consum	ption,																					
S1C17M01	32 x 4 28 x 8	-	16.3M	32.768k	7.37M	0.35	0.8	12.5	210	1.8 to 5.5	32K *3	-	4K	19	5	-	1	1	1	2	-	1	-	1	-	1	0	-	-	-	AMRC	TQFP13-64	0
S1C17M10	88 x 8 80 x 16	-	16M	32.768k	32k/ 4M/8M/ 12M/16M	0.16	0.6	4	145	1.8 to 5.5	64K (*3)	-	4K	33	5	1 x 2	1	1	1	1	-	1	-	-	-	1	0	-	-	1	SMCIF	TQFP15-128	0
S1C17M12	-	LED controller 8x5	16.8M	-	4M/8M/ 12M/16M	0.35	40	-	150	1.8 to 5.5	16K *3	-	2K	39	4	1 x 2	1	-	1	2	-	1	1	-	-	1	0	0	-	1	High current port x 5	TQFP12-48	0
S1C17M13	-	LED controller 8x5	16.8M	-	4M/8M/ 12M/16M	0.35	40	-	150	1.8 to 5.5	16K *3	-	2K	39	4	1 x 2	1	-	1	2	-	1	1	-	8	1	0	0	-	1	High current port x 5	TQFP12-48	0
S1C17M20	-	-	21M	- 32.768k	32k/700k/ 12M/16M/20M	0.36	1.5 0.7	5.5 5	160	1.8 to 5.5	16K (*3)	-	2K	18 24	4	2 x 2	1	1	2	2	-	1	1	-	4 6	1	0	0	1	1	-	SQFN4-24 SQFN5-32	-
S1C17M21	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	16K (*3)	-	2K	24	4	2 x 2	1	1	2	2	-	1	1	-	6	1	0	0	1	1	-	TQFP12-32	-
S1C17M22	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	16K (*3)	-	2K	40	4	2 x 2	1	1	2	2	-	1	1	2	8	1	0	0	1	1	-	TQFP12-48	-
S1C17M23	-	-	21M	- 32.768k	32k/700k/ 12M/16M/20M	0.36	1.5 0.7	5.5 5	160	1.8 to 5.5	32K (*3)	-	2K	18 24	4	2 x 2	1	1	2	2	-	1	1	-	4 6	1	0	0	1	1	-	SQFN4-24 SQFN5-32	-
S1C17M24	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	32K (*3)	-	2K	24	4	2 x 2	1	1	2	2	-	1	1	-	6	1	0	0	1	1	-	TQFP12-32	_
S1C17M25	-	-	21M	32.768k	32k/700k/ 12M/16M/20M	0.36	0.7	5	160	1.8 to 5.5	32K (*3)	-	2K	40	4	2 x 2	1	1	2	2	-	1	1	2	8	1	0	0	1	1	-	TQFP12-48	-
S1C17M30	26 x 4 22 x 8 *6	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	48K (*3)	256 *8	4K	38	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP12-48	-
S1C17M31	26 x 4 22 x 8	-	16.8M	-	32k/700k/ 12M/16M	0.2	1.4	5.5	160	1.8 to 5.5	48K (*3)	256 *8	4K	38	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP12-48	-
S1C17M32	42 x 4 38 x 8 *6	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	64K (*3)	256 *8	4K	54	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP13-64	-
S1C17M33	50 x 4 46 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	96K (*3)	32 to 512	4K	66	4	3 x 2	1	1	2	2	-	1	1	2	5	1	0	0	1	1	-	TQFP14-80	0
S1C17M34	37 x 4 33 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	64K (*3)	256 *8	4K	52	4	3 x 2	1	1	2	2	-	1	1	2	5	1	0	0	1	1	-	TQFP13-64	-
S1C17M40	40 x 4 36 x 8	-	16.8M	32.768k	32k/700k/ 16M	0.25	0.7	5	-	1.8 to 5.5	48K	256	2K	55	4	3 x 2	1	1	3	2	-	1	1	-	4	1	0	0	1	1	-	QFP13-64	-
3101710140	28 x 4 24 x 8	-	16.8M	-	32k/700k/ 16M	0.25	1.4	5.5	-	1.8 to 5.5	48K	256	2K	41	4	3 x 2	1	1	3	2	-	1	1	-	3	1	0	0	1	1	-	TQFP12-48	-

^{*1:} During erasing / programming in flash memory /EEPROM programming (Vob): Vr≥=2.2V to 5.5V *2: During erasing / programming in flash memory (Vob): 2.7V to 5.5 V, 2.4V to 5.5V during the external applying Ve≥=7.5V / 7.5V (Typ.)

^{*3:} During erasing / programming voltage in flash memory (Vpp): The external applying of 7.5V / 7.5V (Typ.) is needed. (*3) can be rewritten even with internal power supply.

^{*4:} SVD is an abbreviation for Supply Voltage Detector. *5: Output dedicated port 1 included

^{*6:} External voltage application mode only. to 5.5V

^{*7: (}MR sensor controller) Operation (VDD): 2.0V to 5.5V

^{*9}: During erasing / programming in flash memory (VDD): 2.4V to 5.5V

S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

MCUs

■ S1C17 Long-running Series

	Display		Operation cloc	k		Supply	current		Power supply		Memory		I/O				Timer						SIO				Analog			Other	s	Form of deli	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [μΑ] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	Mask ROM [Byte]	RAM [Byte]	I/O port	8-bit timer	16-bit timer	16-bit PWM timer	Stopwatch	Watchdog timer	Clock	Real-time clock	UART	SPI	I²C master	l²C slave	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (10-bit)	SVD *5	Sound	Multiplier /Divider	Special function	Package	C
51C17100/600 seri	ies	[Low Powe This produc	r] This is a 16-b ct is equipped v	it MCU with imposith a built-in seg	roved processin ment LCD drive	ng capacity and er, power circuit	development en , clock function	vironment, wi	hile maintaining F, suitable for wa	low power cons	sumption equiva	lent to and		n's 4/8-bit hcare devi																			
51C17153	32 x 4	-	32.768k	500k/1M/2M	0.13	0.42	4	160	2.0 to 3.6	-	16K	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	-	
1C17121	40 x 4 36 x 8	4.2M	32.768k	2.7M	0.15	0.9	7	250	1.8 to 3.6	-	32K	2K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
1C17651	20 x 4	4.2M	32.768k	32k/500k/ 1M/2M	0.09	0.42	10	350	2.0 to 3.6	16K *3	-	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	TQFP13-64	
1C17653	32 x 4	4.2M	32.768k	32k/500k/ 1M/2M	0.09	0.42	10	350	2.0 to 3.6	16K *3	-	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	TQFP14-80	
1C17656	32 x 4	-	32.768k	500k/ 1M/2M/4M	0.13	0.5	7.3	280	1.8 to 3.6	24K *4	-	2K	20	1	-	1	-	1	1	1	1	1	-	-	-	1	-	1	1	1	-	TQFP14-80	
1C17611	12 x 4 8 x 8	8.2M	32.768k	2.7M	0.6	2.0	12	400	1.8 to 3.6	32K *6	-	2K	19	2	3	2	1	1	1	-	1	1	1	1	-	1	4	1	-	1	-	QFP12-48	
IC17601	20 x 4 16 x 8	8.2M	32.768k	2.7M	0.6	2.0	12	340	1.8 to 3.6	32K *6	-	2K	24	2	3	2	1	1	1	-	1	1	1	1	-	1	4	1	-	1	-	TQFP13-64	
IC17621	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.5	15	410	1.8 to 3.6	32K *6	-	2K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
IC17602	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.5	15	410	1.8 to 3.6	64K *6	-	4K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
C17622	56 x 4 52 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	64K *6	-	4K	47	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP15-128	
C17604	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	128K *6	-	8K	36	3	3	3	1	1	1	1	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
1C17624	56 x 4 52 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	128K *6	-	8K	47	3	3	3	1	1	1	1	2	1	1	1	1	2	8	1	-	1	-	TQFP15-128	
IC17500 series		[Low Power] This is a 16-bi	t MCU with built-	in flash memo	ry, which realize	s high-speed pro	ocessing at lov	w power consum	nption. This prod	duct is equipped	with various	feature	es, such as	a genera	al-purpose	I/O port,	A/D conve	erter inpu	t and seria	l I/F, and i	s suitable	for cont	rolling vari	ous senso	or built-in	devices, i	ncluding l	nouseholo	d appliance	es.		
IC17564	-	24M	32.768k	2M to 12M	0.8	2.7	16	450	2.0 to 5.5	128K *3	-	16K	40	-	5	4	1	1	1	-	2	3	1	1	1	-	4	-	1	-	-	TQFP13-64 VFBGA5H-81	
				4M/8M/						1201			88 68														16					QFP15-100 QFP14-80	
1C17589	-	16.8M	32.768k	12M/16M	0.2	0.6	9	280	1.8 to 5.5	128K *4	-	16K	52	-	6	4 x 6	-	1	-	1	3	2	1	1	1	-	11 7	1	1	-	-	QFP13-64	
IC17700 series				ed series. It is a 1 oltages from 1.8		h Flash memory	compatible with	n high process	ing while achiev	ing low power o	consumption,																						
1C17711	64 x 16 56 x 24	8.2M	32.768k	2.7M	1.0	2.0	12	400	1.8 to 3.6	64K	-	4K	29	_	4	4	1	1	1	_	1	1	1	1	1	2	8	1	-	1	-	TQFP15-128	
IC17702	88 x 16 72 x 32	8.2M	32.768k	2.7M	1.0	2.5	16	450	1.8 to 3.6	128K *6	-	12K	28	3	3	2	1	1	1	-	1	1	1	-	1	-	-	1	-	1	-	QFP21-176 VFBGA10H-180 VFBGA8H-181	
IC17703	120 x 16/24/32 60 x 64	8.2M	32.768k	2.7M	1.0	2.5	15	450	1.8 to 3.6	256K *6	-	12K	34	-	5	4	1	1	1	-	2	3	1	1	1	2	8	1	-	1	-	QFP21-216 VFBGA10H-240	
C17705	128 x 16/24/32 64 x 64	8.2M	32.768k	2.7M	1.2	2.7	18	550	1.8 to 3.6	512K *6	-	12K	35	-	5	4	1	1	1	-	2	3	1	1	1	2	8	1	-	1	-	VFBGA10H-240	
1C17800 series				i-bit MCU realized provides maximu				eauipped with	abundant built-	-in I/F. such as U	SB. various seria	interfaces	and A	D convert	ers. suital	ble for ope	eration pa	anel contro	ol of white	e home ap	pliances a	and variou	us produc	ts. with in	nproved u	ser interfa	ace utilizir	na displav	s. music.	sound. to	uch panels an	d etc.	
IC17801	LCD Controllers	48M	32.768k	-	1.4 *10	12	-	6000	3.0 to 3.6	128K *6	-	4K	99	6	2	1	-	1	-	1 *11	1	2	1	-	1	-	8	-	Multiplier :O	-	BUS supported USB FS	TQFP15-128	
C17803	LCD Controllers	33M	32.768k	-	1.3 *10	5	-	6500	2.7 to 5.5	128K *6	-	16K	97 69	4	1	2	-	1	-	1	1	2 *12	1	1	1	-	4	-	1	-	BUS supported	TQFP15-128 TQFP14-100	
C17900 series				ncorporating low a variety of senso								r conventional	batter	y-driven d	evices to	perform, v	with extre	emely low	power co	onsumption	า.												
		24M	32.768k	2M/4M/	1.0	2.9	15	400	2.0 to 3.6	128K		16K	24		-	4	1	1	1		2	2	1	1	1		6	_	1	_	FSA *13	TQFP13-64	

^{*13:} Low power DSP

	Display		Operation clos	ck		Supply	current		Power supply		Memory		I/O				Timer						SIO				Analog		Oth	ers	Form of deliv	very
Products	EPD Driver seg (TP/BP)	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	RTC [µA] (Typ.)	32kHz Operating [μΑ] (Typ.)	1MHz operating [μΑ] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	EEPROM [Byte]	RAM [Byte]	I/O port	8-bit timer	16-bit timer	16bit-PWM timer	Stopwatch	Watchdog timer	Clock	Real-time clock	UART	SPI	I ² C master	I ² C slave	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter	SVD*1	Multiplier/Divider	Temparature detection circuit	Package	Chip
S1C17F50 series		[Medium and maximize the	small segment E characteristics of	PD] The product als an e-paper display v	o includes embe	edded features su	ich as a real-time	clock, theoretical	al regulation, a drive	r capable of wri	nging the maxin	num	perfo	ormance fr	om segme	nted EPDs,	and a tem	nperature :	sensor. A	s a result,	the device	does not	simply driv	ve the dis	play, but al	so corrects	temperat	ure effects	s that coul	ld harm disp	play quality making it	possible to
S1C17F57	64 (2TP/2BP)	4.2M	32.768k	32k/500k/1M/2M	0.10	0.21	12	410	2.0 to 3.6	32K*2	-	2K	29	2	-	2	1	1	1	1	1	1	1	1	-	1	-	1	1	1	-	*3
S1C17F63	42 (1TP/1BP)	16.8M	32.768k	500k/700k/1M/ 2M/4M/8M/16M	0.45	0.11	5	305	1.8 to 5.5	32K*2	256	2K	17	-	4	2 x 2	-	1	-	1	1	2	1		-	-	7	1	1	1	QFP15-100	*3

^{*1:} SVD is an abbreviation for Supply Voltage Detector.

18

^{*4:} During erasing / programming voltage in flash memory (Vpp): The external applying of 7.5V / 7.5V (Typ.) is needed. *5: SVD is an abbreviation for Supply Voltage Detector. *6: This product uses SuperFlash® technology licensed from SST UK Ltd.

^{*1:} During erasing / programming in flash memory (Vpb): 2.7V to 3.6 V
*2: During erasing / programming in flash memory (Vpb): 2.5V to 3.6 V
*3: During erasing / programming voltage in flash memory (Vpp): The external applying of 7.5V / 7.0V (Typ.) is needed.

^{*7:} Al pad, Au bump *8: Including Input port and Output port. *9: Resolution: 12-bit

^{*10:} Unmounted OSC1 *11: The battery backed up operation is supported. *12: Universal serial interface (Any of UART, SPI and I²C functions can be selected.)

^{*2}: During erasing / programming voltage in flash memory (Vpp) : The external applying of 7.0V / 7.5V (Typ.) is needed.

^{*3:} Al pad, Au bump

^{*4:} Including Input port and Output port.

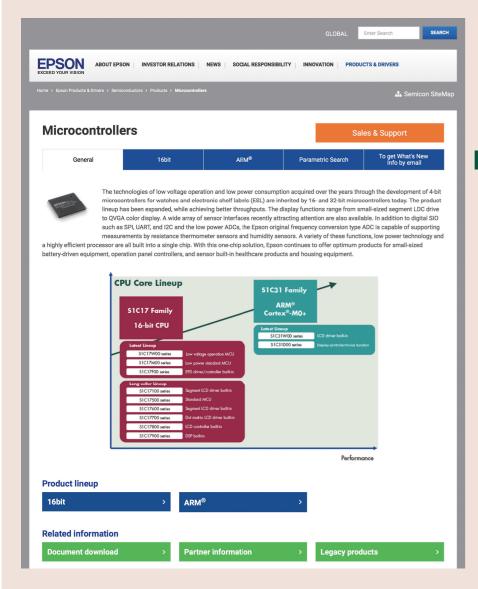
Epson MCU website

Epson MCU website

MCUs

global.epson.com/products_and_drivers/semicon/products/micro_controller/

On the Epson MCU website, you can access a variety of information required for device selection and design development.



Downloadable information

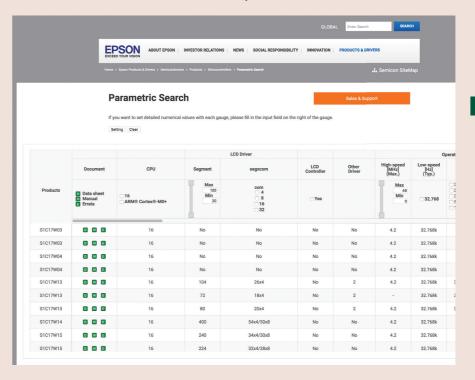
- · Hardware Development Tool
- · Software Development Tool
- · Application Note
- · Sample Program
- MP Support Tool

Microcontrollers Parametric Search

It's useful for your model selection of microcontrollers.

You can download Data sheets, Technical manuals and Manual errata sheets.

21



Downloadable information

- · Data sheets
- · Technical manuals
- Manual errata sheets

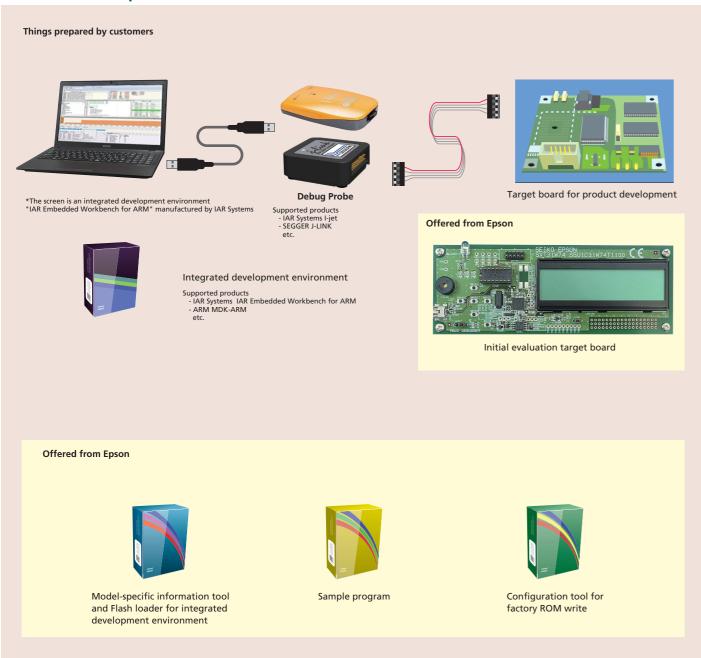
MCUs MCUs

Development environments - S1C31 Family -

Development environments - S1C31 Family -

MCUs

■ Overall development environment



■ Development support tool (Evaluation board)

- S1C31 chip built in
- Possible to evaluate the IC functions
- Provides a sample sources for various functions
- Debugging and Flash programming supported



SVTmini31W65

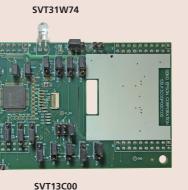














SVT31D01

SVT31D50

Model Name	Product Name	Mounted Microcontroller Name	Remarks
SVTmini31W65	S5U1C31W65T2	S1C31W65	
SVTmini31W73	S5U1C31W73T2	S1C31W73	
SVT31W74	S5U1C31W74T1	S1C31W74	Dot matrix liquid crystal panel, Infrared LED, USB connector, Bridge Board
SVT31D01	S5U1C31D01T1	S1C31D01	Color memory display, Acceleration gyro sensor, Pulse sensor, Bridge Board
SVT31D50	S5U1C31D50T1	S1C31D50	AMP(class AB, class D), SPI-FLASH(8MB)
SVT13C00	S5U13C00K00C	S1D13C00	Color memory display, Bridge Board for connecting to Host CPU

■ 3rd Party tool inquiries

Integrated Development Environment, Debug Probe



IAR Systems K.K. www.iar.com/buy/ Debug & Trace Probes, Flasher / In-Circuit Programmers



SEGGER Microcontroller GmbH www.segger.com

23

Development environments - S1C17 Family -

MCUs

GNU17 package

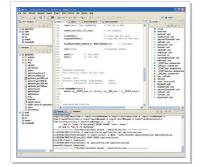
Optimized C compiler supporting 16MB space Assembler, linker and **ANSI library** GUI-based debugger Eclipse integrated environment



On-chip ICE, S1C17 Family products are supported. Connect with the target board with 4 pins at minimum (3 signal pins and 1 GND pin). Includes execution time measurement function. Uses USB bus power.

Can be used as a Multi Programmer. Includes firmware update function.

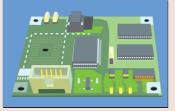
Power supply function for target devices of 3.3V.





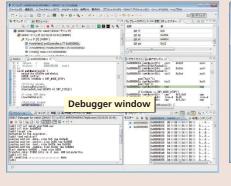






Target board for product development

■ Development support tool (Software simulator)





10-line cable (DCLK, DSIO, DST2, GND)

- •Simulatable on PC including the LCD display, without using external debugging hardware or using an actual chip, it is possible to simulate only the LCD display (Custom-made LCD Panels can be created)
- •Ability to show various data at the same time in multiple windows
- •Ability to execute frequently using commands from the tool bar or menus
- Function of displaying C source, program code and symbols using disassembler
- Consecutive program execution and 3 types of step executions
- •3 types of break functions
- Trace and coverage functions
- Automatic command execution using command files

Development environments - S1C17 Family -

■ Development support tool (Evaluation board)

- S1C17 chip built in
- Possible to evaluate the IC functions
- Provides a sample software for various functions
- Debugging and Flash programming supported

































SVT17W15

















SVTmini17564



SVTmini17589





SVTmini17611 SVT17656 SVTmini17656

SVT17702

	_		
Model Name	Product Name	Mounted Microcontroller Name	Remarks
T17F57	S5U1C17F57T11	S1C17F57	Segment EPD panel
Tmini17F57	S5U1C17F57T21	S1C17F57	
Tmini17F63	S5U1C17F63T21	S1C17F63	Segment EPD panel
T17M01	S5U1C17M01T11	S1C17M01	LCD panel, MR Sensor with EEPROM
Tmini17M10	S5U1C17M10T21	S1C17M10	
T17M13	S5U1C17M13T11	S1C17M13	7 seg LED 5 digits, EEPROM, Infrared LED, Key matrix 3x4

SVT17F57	S5U1C17F57T11	S1C17F57	Segment EPD panel
SVTmini17F57	S5U1C17F57T21	S1C17F57	
SVTmini17F63	S5U1C17F63T21	S1C17F63	Segment EPD panel
SVT17M01	S5U1C17M01T11	S1C17M01	LCD panel, MR Sensor with EEPROM
SVTmini17M10	S5U1C17M10T21	S1C17M10	
SVT17M13	S5U1C17M13T11	S1C17M13	7 seg LED 5 digits, EEPROM, Infrared LED, Key matrix 3x4
SVTmini17M25	S5U1C17M25T21	S1C17M25	
SVT17M33	S5U1C17M33T11	S1C17M33	Reference board of remote controller
SVTmini17M33	S5U1C17M33T21	S1C17M33	
SVTmini17M40	S5U1C17M40T21	S1C17M40	
SVTmini17M13	S5U1C17M13T21	S1C17M13	
SVTmini17W04	S5U1C17W04T21	S1C17W04	
SVTmini17W12	S5U1C17W12T21	S1C17W12	
SVTmini17W13	S5U1C17W13T21	S1C17W13	
SVTmini17W14	S5U1C17W14T21	S1C17W14	
SVT17W15	S5U1C17W15T11	S1C17W15	JDI memory display panel, Piezoelectric buzzer
SVTmini17W15	S5U1C17W15T21	S1C17W15	
SVTmini17W16	S5U1C17W16T21	S1C17W16	
SVTmini17W18	S5U1C17W18T21	S1C17W18	
SVT17W23	S5U1C17W23T11	S1C17W23	LCD panel, Piezoelectric buzzer
SVTmini17W36	S5U1C17W36T21	S1C17W36	
SVTmini17564	S5U1C17564T21	S1C17564	
SVTmini17589	S5U1C17589T21	S1C17589	
SVT17602	S5U1C17602T11	S1C17602	LCD panel, Remote control transmitter and receiver, Thermal/Humidity/Illuminance sensor
SVTmini17611	S5U1C17611T21	S1C17611	
SVT17656	S5U1C17656T11	S1C17656	LCD panel, Capacitive touch button, Piezoelectric buzzer
SVTmini17656	S5U1C17656T21	S1C17656	
SVT17702	S5U1C17702T11	S1C17702	LCD panel, Remote control transmitter and receiver
SVT17801	S5U1C17801T11	S1C17801	LCD module(QVGA), Touch Panel, Voice Input/Output, USB, Remote control transmitter and receiver, Various
SVTmini17803	S5U1C17803T21	S1C17803	

25

MCUs

SVTmini17965

S5U1C17965T21

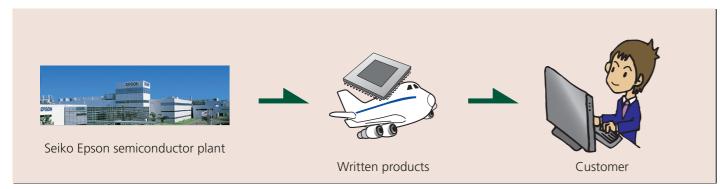
S1C17965

MCUs Flash memory writing

Flash memory writing

MCUs

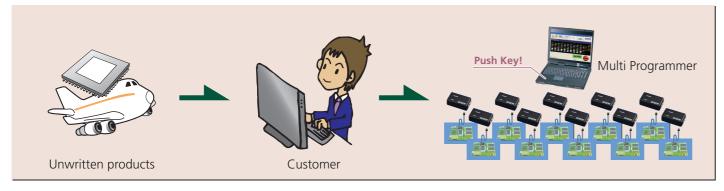
■ If you procure written products from a Seiko Epson dealer

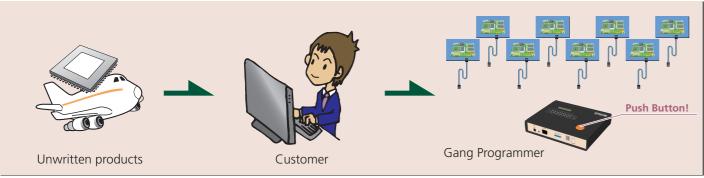


■ If you write to flash memory on your side (Single writing)



■ If you write to flash memory on your side (Simultaneous multiple writing)



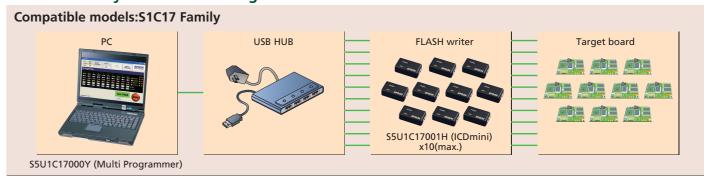


On-board writing tools and environments



- A single S5U1C17001H2 (ICDmini) unit operates as an on-chip flash writer. Simply by pressing a button, user data previously saved in the ICDmini can be written to the internal flash ROM on the target board, or the flash ROM connected to the external bus.
- You can enjoy on-board programming easily at any location where a 5V power supply is available
- * Power supply to the target board is required separately.
- * The product does not include the target board, and AC adapter or battery box to supply power to USB terminals.

■ S1C17 Family On-board writing tools and environments



- Up to 10 units of the S5U1C17001H (ICDmini) can be used to construct an environment enabling user data to be downloaded simultaneously
- The S5U1C17000Y, Multi Programmer software that controls the ICDmini, provides user-friendly screen and simple operation.
- * Power supply to the target board is required separately.
- * The product does not include the target board, PC and the USB hub operating on self-power



- A single S5U1C1700W unit downloads user data simultaneously to maximum 8 targets.
- SD card is used to input user data, and the operating status can be checked by LCD, LED and buzzer.
- A serial number writing function is also built-in.



• SEGGER J-Link or Flasher / Any debug probe or flash programmer that supports J-Flash software tool can be used.

MCUs Package lineup

Package lineup

MCUs

■ QFP & TQFP & SQFN

PKG typ	pe/Pin count	Body size (mm)	Lead pitch (mm)
SQFN4-24		4 X 4 X 1.0	0.5
SQFN5-32		5 X 5 X 1.0	0.5
TQFP12-32		7 X 7 X 1.2	0.8
QFP12-48		7 X 7 X 1.7	0.5
SQFN7-48	AMAZANI AMAZANI	7 X 7 X 1.0	0.5
TQFP12-48		7 X 7 X 1.2	0.5
SQFN9-64		9 X 9 X 1.0	0.5
QFP13-64		10 X 10 X 1.7	0.5
TQFP13-64		10 X 10 X 1.2	0.5
TQFP14-80		12 X 12 X 1.2	0.5
QFP14-80		12 X 12 X 1.7	0.5

PKG type/Pin count	Body size (mm)	Lead pitch (mm)
QFP15-100	(mm)	(mm)
QTY 13-100	14 X 14 X 1.7	0.5
TQFP14-100	12 X 12 X 1.2	0.4
TQFP15-128	14 X 14 X 1.2	0.4
QFP21-176	24 X 24 X 1.7	0.5
QFP21-216	24 X 24 X 1.7	0.4

■ WCSP

PKG type/Pin count	Body size (mm)	Ball pitch (mm)
WCSP-96 (S1C31D01)	4.5 X 4.5 X 0.7	0.4

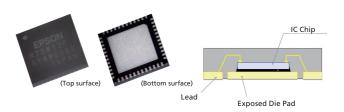
QFP



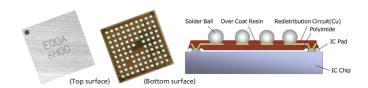
■ Compact BGA (PFBGA) & Thin type BGA (VFBGA)

PKG type/Pin count	Body size (mm)	Ball pitch (mm)	
VFBGA5H-81	5 X 5 X 1.0	0.5	
VFBGA10H-180	10 X 10 X 1.0	0.65	
VFBGA8H-181	8 X 8 X 1.0	0.5	
VFBGA10H-240	10 X 10 X 1.0	0.5	

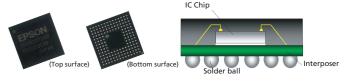
SQFN



WCSP



Thin type BGA (VFBGA)



Memo

MCUs

30

NOTICE

The content of this document is subject to change without notice.

- This document may not be copied, reproduced, or used for any other purpose, in whole or in part, without the consent of Seiko Epson Corporation("Epson").
- Before purchasing or using Epson products, check with our sales representative for the latest information. Always consult Epson's web site or other sources for the latest information.
- 3. Information provided in this document concerning application circuits, programs, usage, etc., are for reference only. Epson makes no guarantees against any infringements of or damages to a third party intellectual property rights or any other rights resulting from the information. Epson does not give any licenses to use the intellectual property rights or any other rights of a third party or Epson under this document.
- 4. Epson is committed to constantly improving quality and reliability, but semiconductor products in general are subject to malfunction and failure. Customers using Epson products assume responsibility for ensuring that their hardware, software, and systems are designed with essential safety to ensure that any malfunction or failure of Epson products would not cause harm to life or health or cause damage to property. During design of the customers' products using Epson products, check the latest information of Epson products (in this document, specifications, data sheets, manuals, Epson's web site, etc.) and comply with the latest information. If using information from technical content, programs, algorithms, examples of application circuits, or other information indicated in product data, schematics, tables, etc., from the above materials, etc., the customers should evaluate their own individual products and overall systems thoroughly and decide whether to use Epson products with the products and systems at their own responsibility.
- 5. Epson has prepared this document carefully and accurately as much as possible, but Epson does not guarantee that the information presented herein is error-free. Epson assumes no responsibility for any damages caused by the customers resulting from information errors in this document.
- 6. No dismantling, analysis, reverse engineering, modification, alteration, adaptation, reproduction, etc., of Epson products is allowed.
- Epson products are intended for use in general applications (office equipment, communications equipment, measuring instruments, home electronics, etc.) and applications individually listed in this document. Our products are not intended for use in the applications specified below where particular quality or reliability is required or where a malfunction or failure could cause harm to life or health or serious damage to property or have a serious impact on society. Customers wishing to use our products in any of the following specified applications (other than applications individually listed in this document) should contact our sales representative in advance.
 - Space equipment (artificial satellites, rockets, etc.)
 - Transportation vehicles and their control equipment (automobiles, aircraft, trains, ships, etc.)
 - Medical equipment intended for maintaining life
 - Relay equipment to be placed on sea floor
 - Power station control equipment
 - Disaster or crime prevention equipment
 - Traffic control equipment
 - Financial equipment
 - Other applications requiring similar levels of reliability as the above
- 8. Epson products listed in this document and our associated technologies may not be used in equipment or systems that are prohibited to manufacture, use or sell under the laws, regulations, or rules in Japan or any other countries. Furthermore, Epson products and our associated technologies may not be used for the purposes of military weapons development (e.g. mass destruction weapons), military use, or any other military applications. If exporting Epson products or our associated technologies, please be sure to comply with the Foreign Exchange and Foreign Trade Control Act in Japan, Export Administration Regulations in the U.S.A (EAR) and other export-related laws and ordinances in Japan and any other countries and follow the required procedures as provided by the relevant laws and ordinances.
- 9. Epson assumes no responsibility if our products are used in violation of conditions listed in this document and such use results in damage.
- 10. Epson assumes no responsibility if customers transfer, loan, etc., our products to a third party and these results in damage.
- 11. For more details or other concerns about this document, contact our sales representative.
- 12. Company names and product names listed in this document are trademarks or registered trademarks of their respective companies.

©Seiko Epson Corporation 2020

[Registered trademarks, trademarks, and company names]

Design Compiler®: Synopsys Inc. in U.S.A.

NC-Verilog®: Cadence Design Systems Inc. in U.S.A.

Compact Flash®: Western Digital Technologies Inc. in U.S.A.

ARM® and Cortex® are the registered trademarks of ARM Limited in the EU and other countries.

SuperFlash® Technology: SST UK Ltd. in U.K.

Other brand names and product names are trademarks or registered trademarks of their respective owners.